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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:
Hsien-Wei Chen, et al.

Serial No.: 10/801,475

Filed: March 16, 2004

For: SYSTEM AND METHOD OF
HEAT DISSIPATION IN
SEMICONDUCTOR DEVICES§
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§Attorney Docket No.
2003-1410 / 24061.193

Customer No. 42717

Group Art Unit: 2822

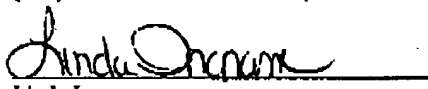
Examiner: Monica Lewis

Confirmation No.: 1783

Mail Stop Amendment
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Sir:

I hereby certify that this correspondence (including any listed enclosures) is being facsimile transmitted to the United States Patent and Trademark Office at (571) 273-8300 on October 20, 2006.


Linda IngramAMENDMENT UNDER 37 C.F.R. §1.111

This Amendment is submitted in reply to the Office Action mailed on August 28, 2006.
(Please see the pages that follow).

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Appl. No. 10/801,475
Reply to Office Action of August 28, 2006

Attorney Docket No. 2003-1410 / 24061.193
Customer No. 42717

Amendment to the Title

Please amend the title of the invention throughout the Patent Office records for this application, so that the title will read as follows:

--- SYSTEM FOR HEAT DISSIPATION IN SEMICONDUCTOR DEVICES ---.